

## Feature

- **N-Channel**

$V_{DD}=40V, I_D=10A$

$R_{DS\ (ON)} < 22m\ \Omega @ V_{GS}=10V$

$R_{DS\ (ON)} < 30m\ \Omega @ V_{GS}=4.5V$

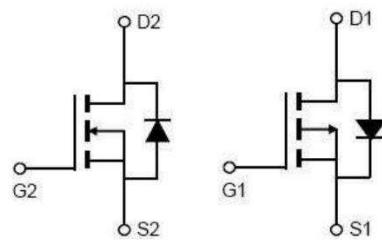
- **P-Channel**

$V_{DD}=-40V, I_D=-12A$

$R_{DS\ (ON)} < 35m\ \Omega @ V_{GS}=-10V$

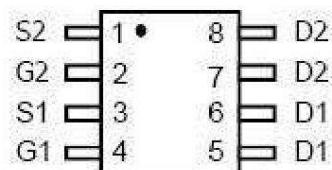
$R_{DS\ (ON)} < 50m\ \Omega @ V_{GS}=-4.5V$

- Lead free product is acquired
- High power and current handing capability
- Surface mount package



N-channel      P-channel

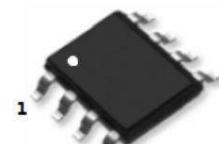
Schematic diagram



Marking and pin assignment

## Application

- PWM applications
- Load Switch
- Power management



SOP-8

## Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity (PCS)
2714SD	AP2714SD	SOP-8	13 inch	-	4000

## ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ C$ unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	$V_{DS}$	40	-40	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	$\pm 20$	V
Continuous Drain Current ( $T_a = 25^\circ C$ )	$I_D$	10	-12	A
Continuous Drain Current ( $T_a = 100^\circ C$ )	$I_D$	6.5	-7.2	A
Pulsed Drain Current <sup>(1)</sup>	$I_{DM}$	40	-45	A
Power Dissipation	$P_D$	4.0	7.5	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	31.3	16.7	$^\circ C/W$
Junction Temperature	$T_J$	150	150	$^\circ C$
Storage Temperature	$T_{STG}$	-55~+150	-55~+150	$^\circ C$

**N-CH ELECTRICAL CHARACTERISTICS( $T_a=25^\circ C$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	40			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = 40V, V_{GS} = 0V$			1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
Gate threshold voltage <sup>(2)</sup>	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1	1.6	2.5	V
Drain-source on-resistance <sup>(2)</sup>	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 10A$		17	22	$m\Omega$
		$V_{GS} = 4.5V, I_D = 6A$		22	30	
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 20V, V_{GS} = 0V, f = 1MHz$		1050		pF
Output Capacitance	$C_{oss}$			84		
Reverse Transfer Capacitance	$C_{rss}$			72		
<b>Switching characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = 20V, I_D = 5A, R_L = 6\Omega$ $V_{GS} = 10V, R_G = 1\Omega$		11		ns
Turn-on rise time	$t_r$			13		
Turn-off delay time	$t_{d(off)}$			36		
Turn-off fall time	$t_f$			9		
Total Gate Charge	$Q_g$	$V_{DS} = 20V, I_D = 5A,$ $V_{GS} = 10V$		11		nC
Gate-Source Charge	$Q_{gs}$			1.9		
Gate-Drain Charge	$Q_{gd}$			2.2		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage <sup>(2)</sup>	$V_{DS}$	$V_{GS} = 0V, I_S = 10A$			1.2	V
Diode Forward current <sup>(3)</sup>	$I_S$		-	-	10	A

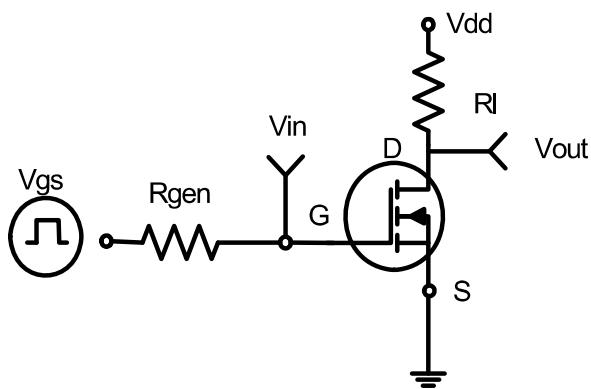
**P-CH ELECTRICAL CHARACTERISTICS( $T_a=25^\circ C$  unless otherwise noted)**

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
<b>Static Characteristics</b>						
Drain-source breakdown voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = -250\mu A$	-40			V
Zero gate voltage drain current	$I_{DSS}$	$V_{DS} = -40V, V_{GS} = 0V$			1	$\mu A$
Gate-body leakage current	$I_{GSS}$	$V_{GS} = \pm 20V, V_{DS} = 0V$			$\pm 100$	nA
Gate threshold voltage <sup>(2)</sup>	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -250\mu A$	-1	-1.6	-2.5	V
Drain-source on-resistance <sup>(2)</sup>	$R_{DS(on)}$	$V_{GS} = -10V, I_D = -8A$		27	35	$m\Omega$
		$V_{GS} = -4.5V, I_D = -5A$		35	50	
<b>Dynamic characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS} = -20V, V_{GS} = 0V, f = 1MHz$		1415		pF
Output Capacitance	$C_{oss}$			134		
Reverse Transfer Capacitance	$C_{rss}$			102		
<b>Switching characteristics</b>						
Turn-on delay time	$t_{d(on)}$	$V_{DD} = -20V, I_D = -5A, R_L = 6\Omega$ $V_{GS} = -10V, R_G = 1\Omega$		22		ns
Turn-on rise time	$t_r$			16		
Turn-off delay time	$t_{d(off)}$			59		
Turn-off fall time	$t_f$			6		
Total Gate Charge	$Q_g$	$V_{DS} = -20V, I_D = -5A,$ $V_{GS} = -10V$		11.5		nC
Gate-Source Charge	$Q_{gs}$			3.5		
Gate-Drain Charge	$Q_{gd}$			3.2		
<b>Source-Drain Diode characteristics</b>						
Diode Forward voltage <sup>(2)</sup>	$V_{DS}$	$V_{GS} = 0V, I_S = -12A$			1.2	V
Diode Forward current <sup>(3)</sup>	$I_S$		-	-	-12	A

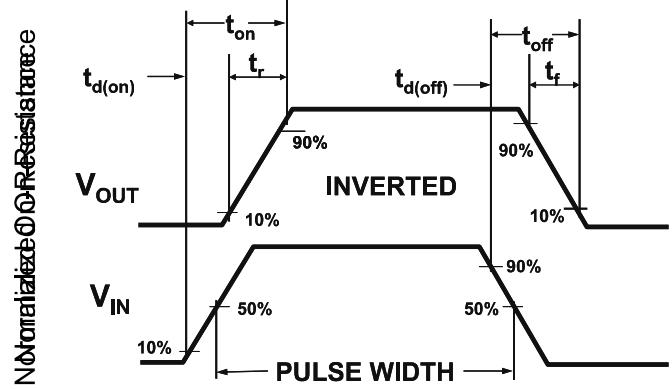
**Notes:**

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. Pulse Test: pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$
3. Surface Mounted on FR4 Board,  $t \leq 10$  sec

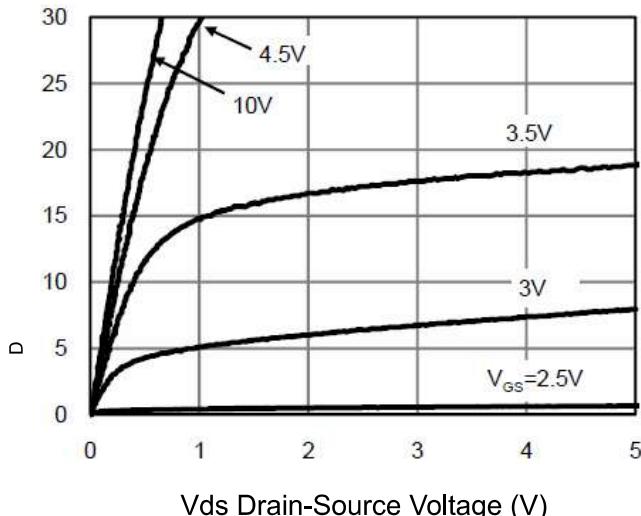
N-Channel



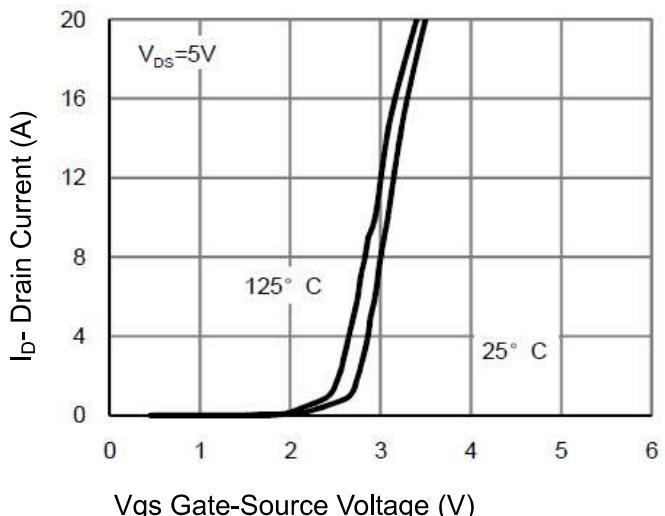
**Figure 1:Switching Test Circuit**



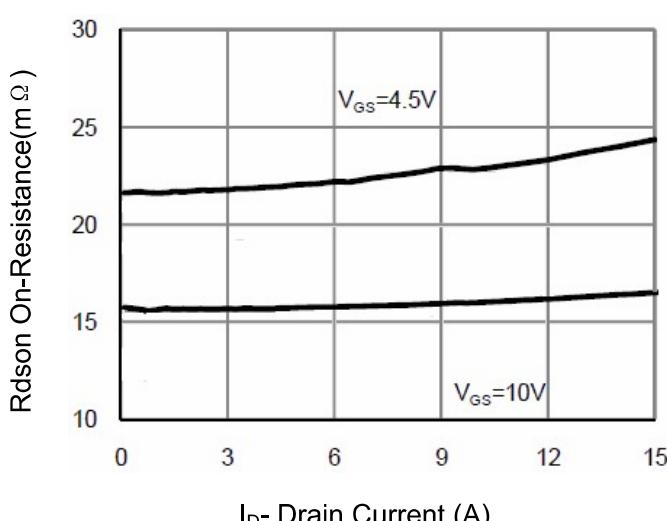
**Figure 2:Switching Waveforms**



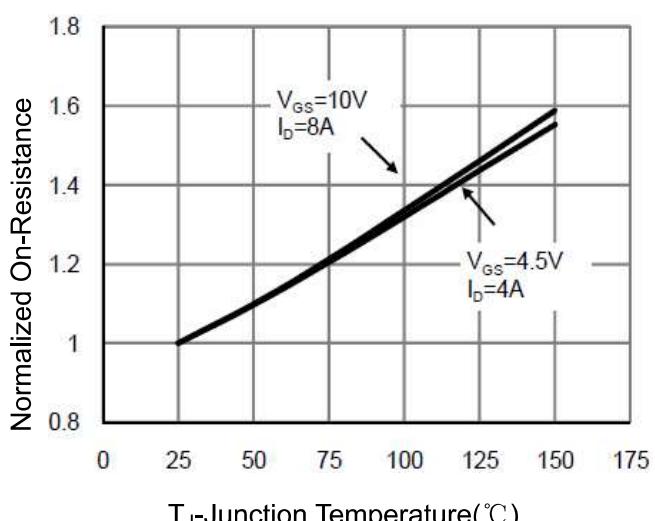
**Figure 3 Output Characteristics**



**Figure 4 Transfer Characteristics**



**Figure 5 Drain-Source On-Resistance**

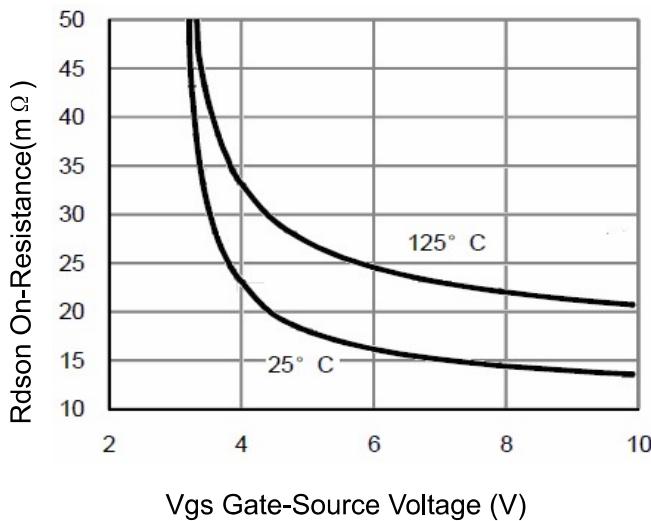


**Figure 6 Drain-Source On-Resistance**

# AP2714SD

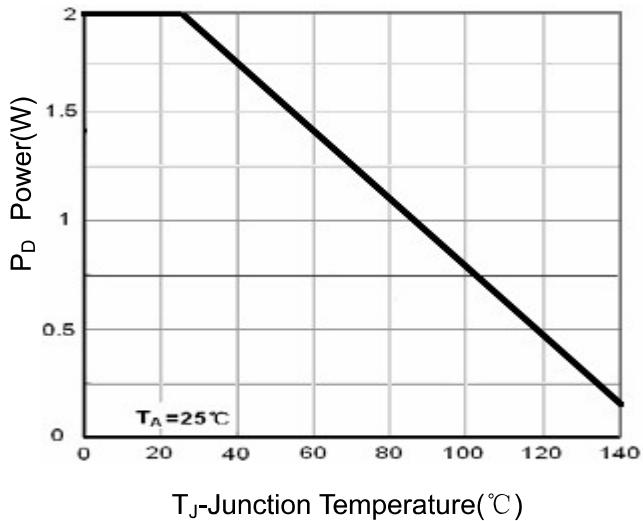
N and P-Channel Enhancement Mosfet

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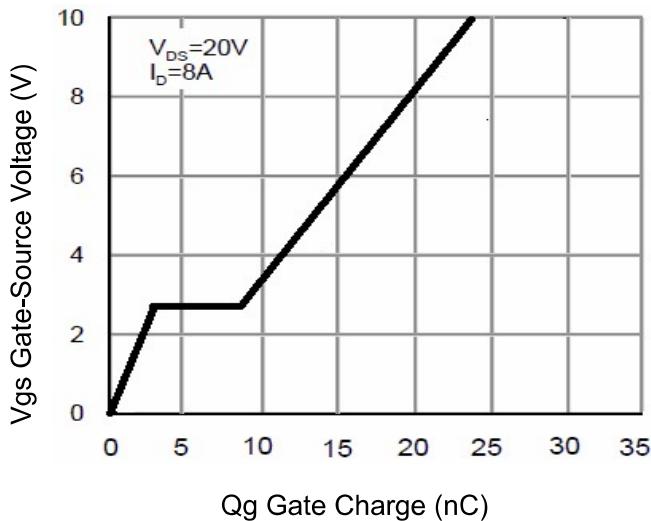
V<sub>GS</sub> Gate-Source Voltage (V)

Figure 7 Rdson vs Vgs



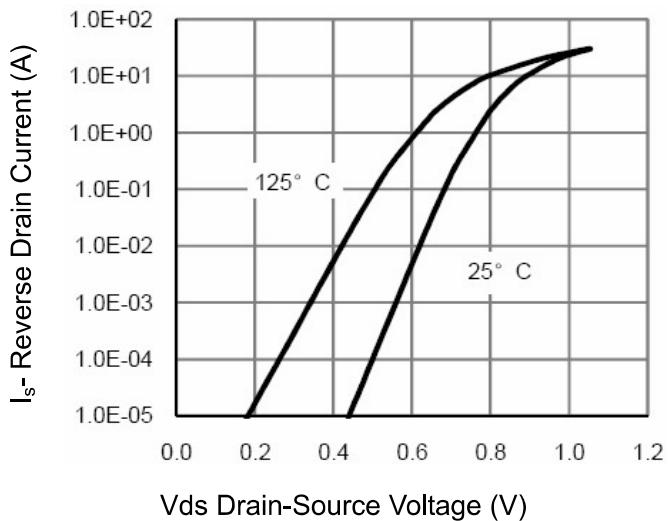
T<sub>J</sub>-Junction Temperature(°C)

Figure 8 Power Dissipation



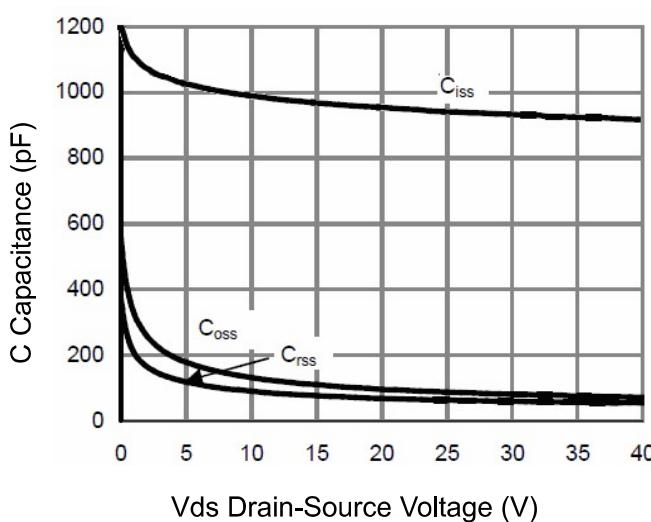
Q<sub>g</sub> Gate Charge (nC)

Figure 9 Gate Charge



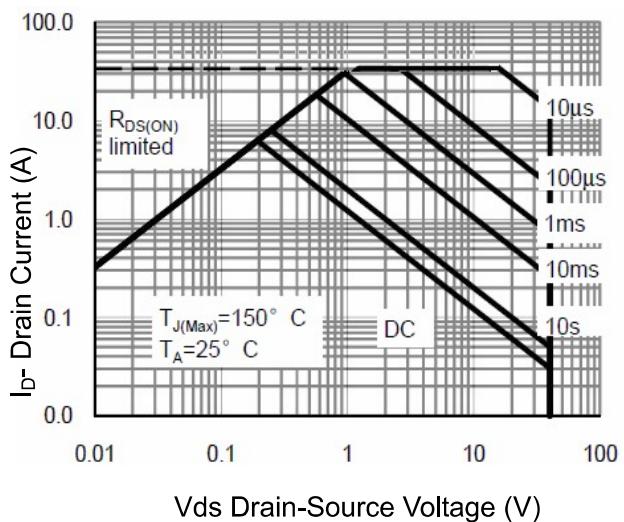
I<sub>s</sub>-Reverse Drain Current (A)

Figure 10 Source- Drain Diode Forward



V<sub>DS</sub> Drain-Source Voltage (V)

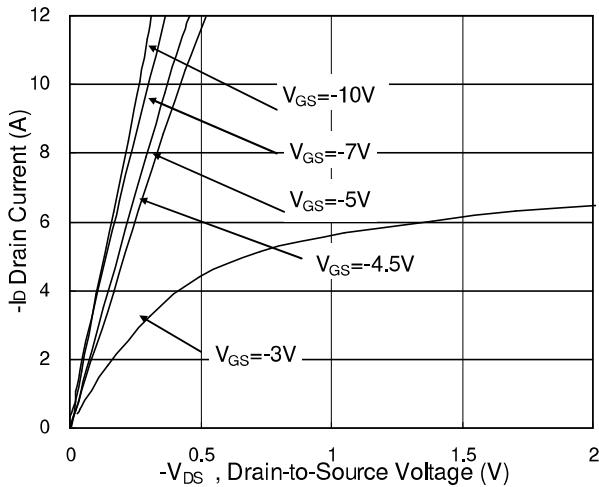
Figure 11 Capacitance vs Vds



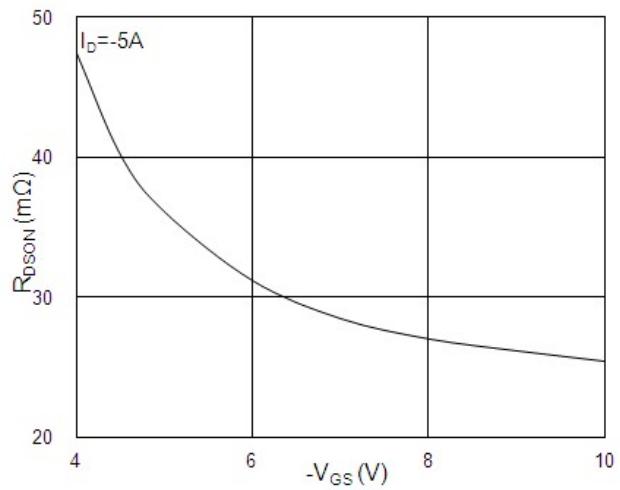
I<sub>D</sub>-Drain Current (A)

Figure 12 Safe Operation Area

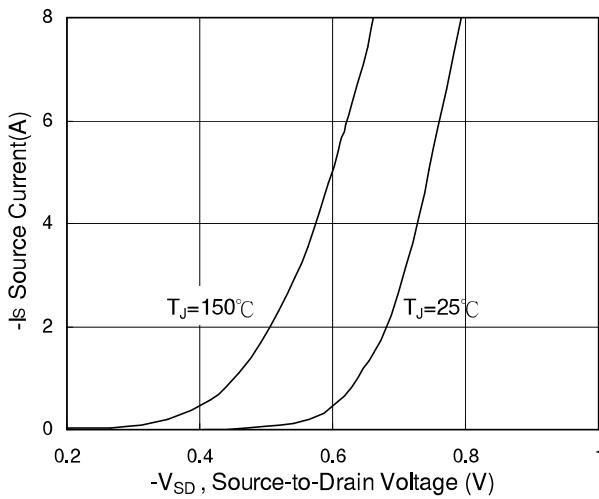
P-Channel



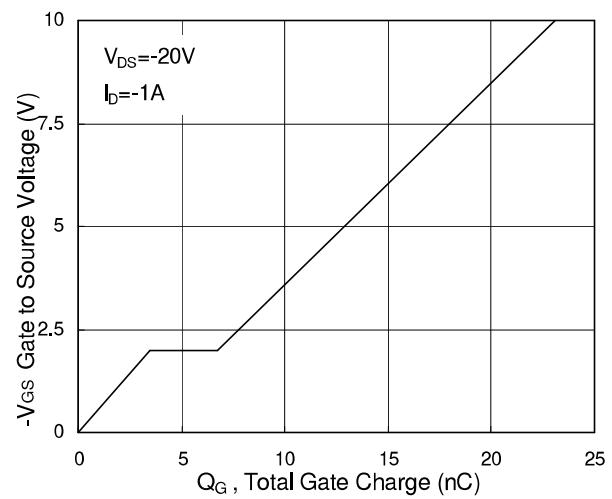
**Fig.1 Typical Output Characteristics**



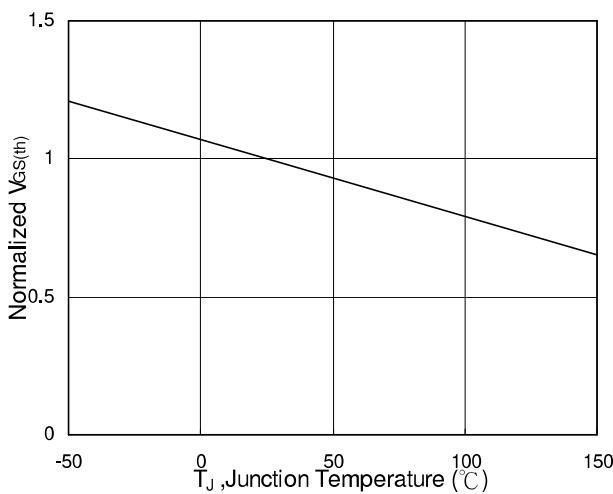
**Fig.2 On-Resistance v.s Gate-Source**



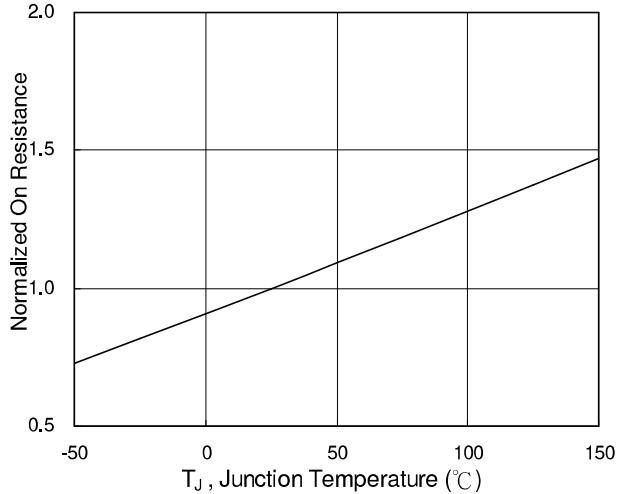
**Fig.3 Forward Characteristics Of Reverse**



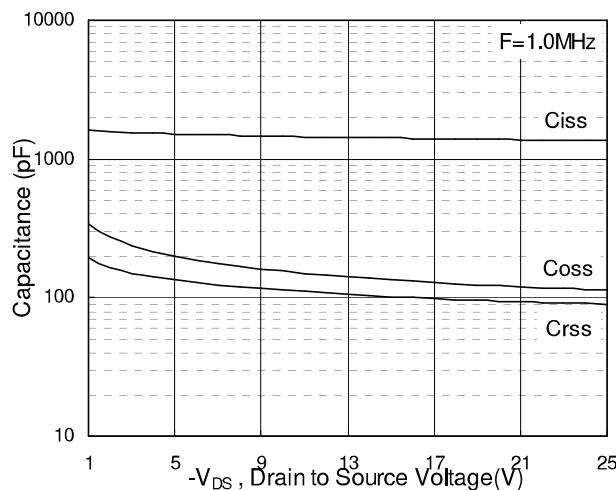
**Fig.4 Gate Charge Characteristics**



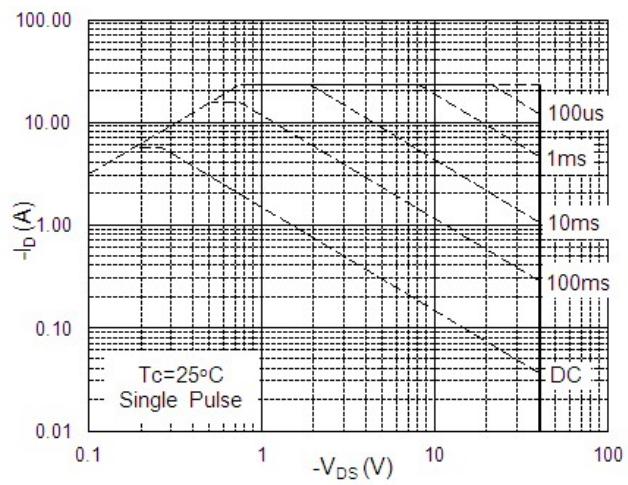
**Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$**



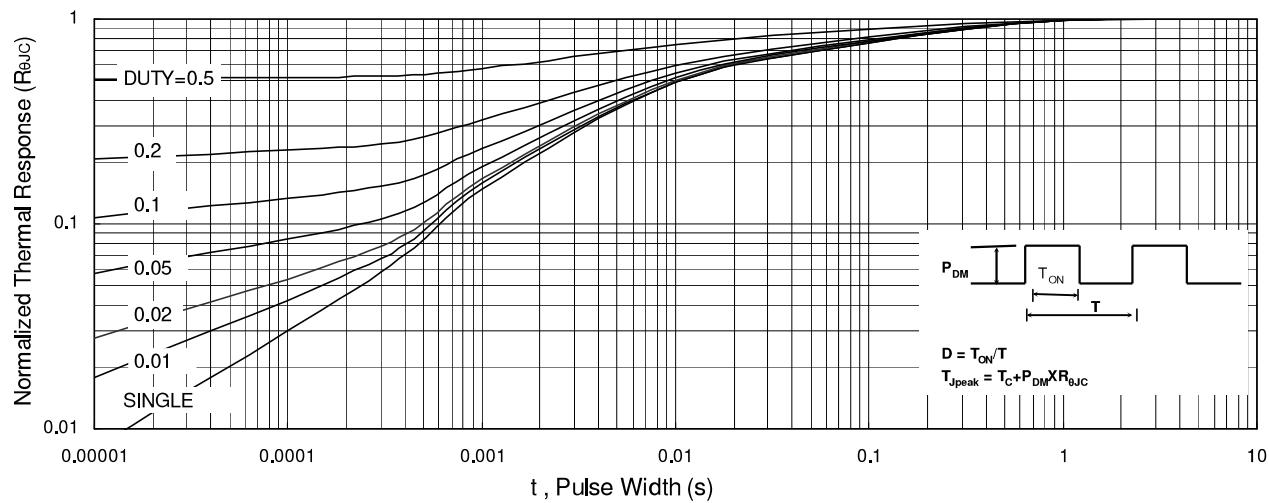
**Fig.6 Normalized  $R_{DS(on)}$  vs.  $T_J$**



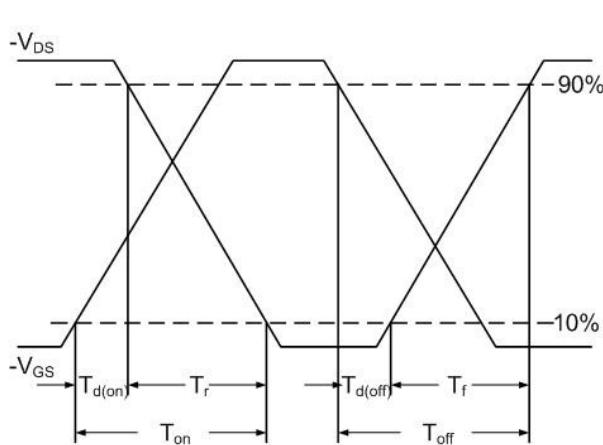
**Fig.7 Capacitance**



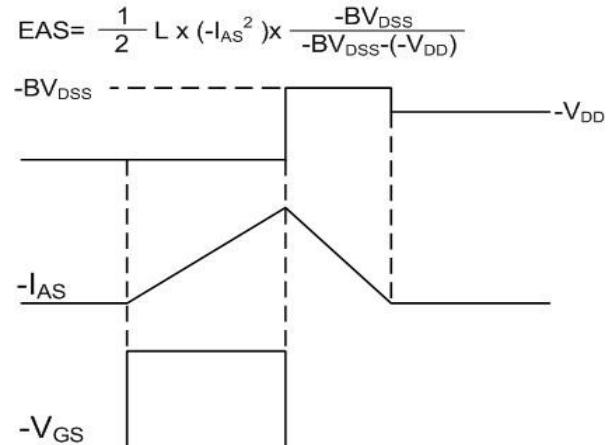
**Fig.8 Safe Operating Area**



**Fig.9 Normalized Maximum Transient Thermal Impedance**

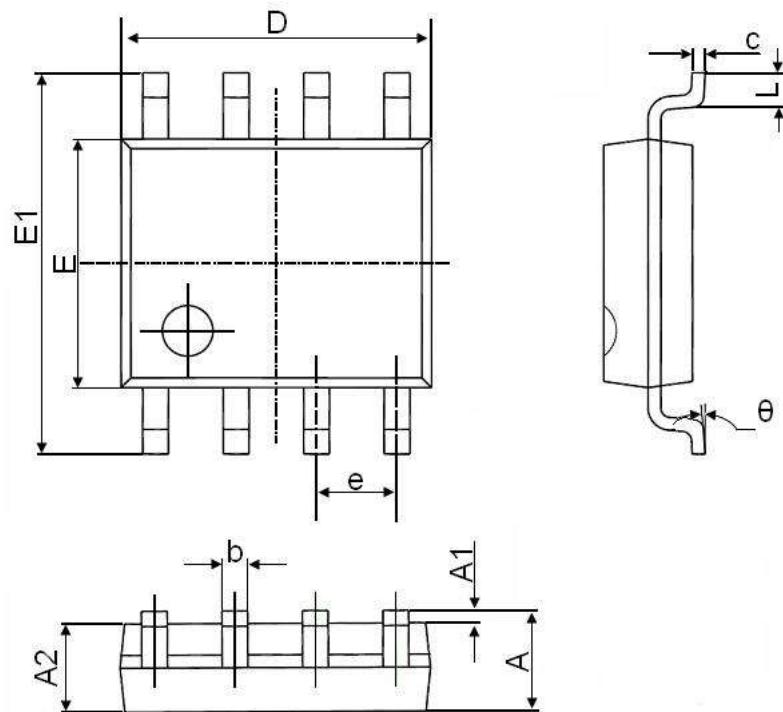


**Fig.10 Switching Time Waveform**



**Fig.11 Unclamped Inductive Switching**

## SOP-8 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270(BSC)		0.050(BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

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